

# **HDSP-Ax11/-Ax13 Series, HDSP-Fx11/-Fx13 Series, HDSP-Hx11/-Hx13 Series, HDSP-Kx11/-Kx13 Series**

## **Black Surface Seven-Segment Displays**



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### **Description**

This Broadcom® family of black surface seven-segment displays uses an industry-standard size package and pinout, and is available with a black surface finish. All devices are available as either common anode or common cathode.

Typical applications include appliances, channel indicators of TV, CATV converters, game machines, and point of sale terminals.

### **Features**

- Black surface and color tinted epoxy
- Industry-standard size
- Industry-standard pinout
- Choice of character size: 7.6 mm (0.30 in.), 10 mm (0.40 in.), 14.2 mm (0.56 in.)
- Choice of colors: AlInGaP deep red, high-efficiency red (HER), high-performance green, orange
- Excellent appearance
  - Evenly lighted segments
  - $\pm 50^\circ$  Viewing angle
- Design flexibility:
  - Common anode or common cathode
  - Single and two digit
- Categorized for luminous intensity
  - Categorized for color: Green
  - Use of like categories yields a uniform display
- Excellent for long digit string multiplexing

## Package Drawings and Internal Circuit Diagrams

Figure 1: Package Dimensions (7.6-mm Series) and Internal Circuit Diagram

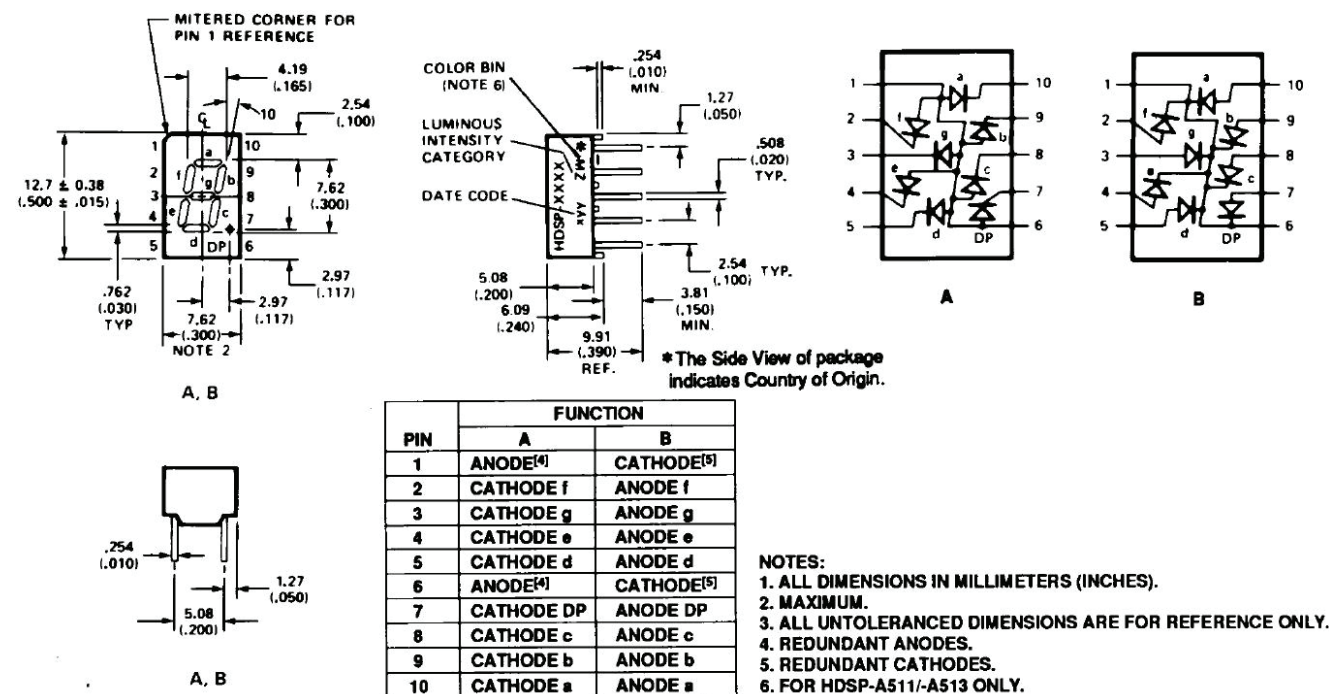


Figure 2: Package Dimensions (10-mm Series: Single) and Internal Circuit Diagram

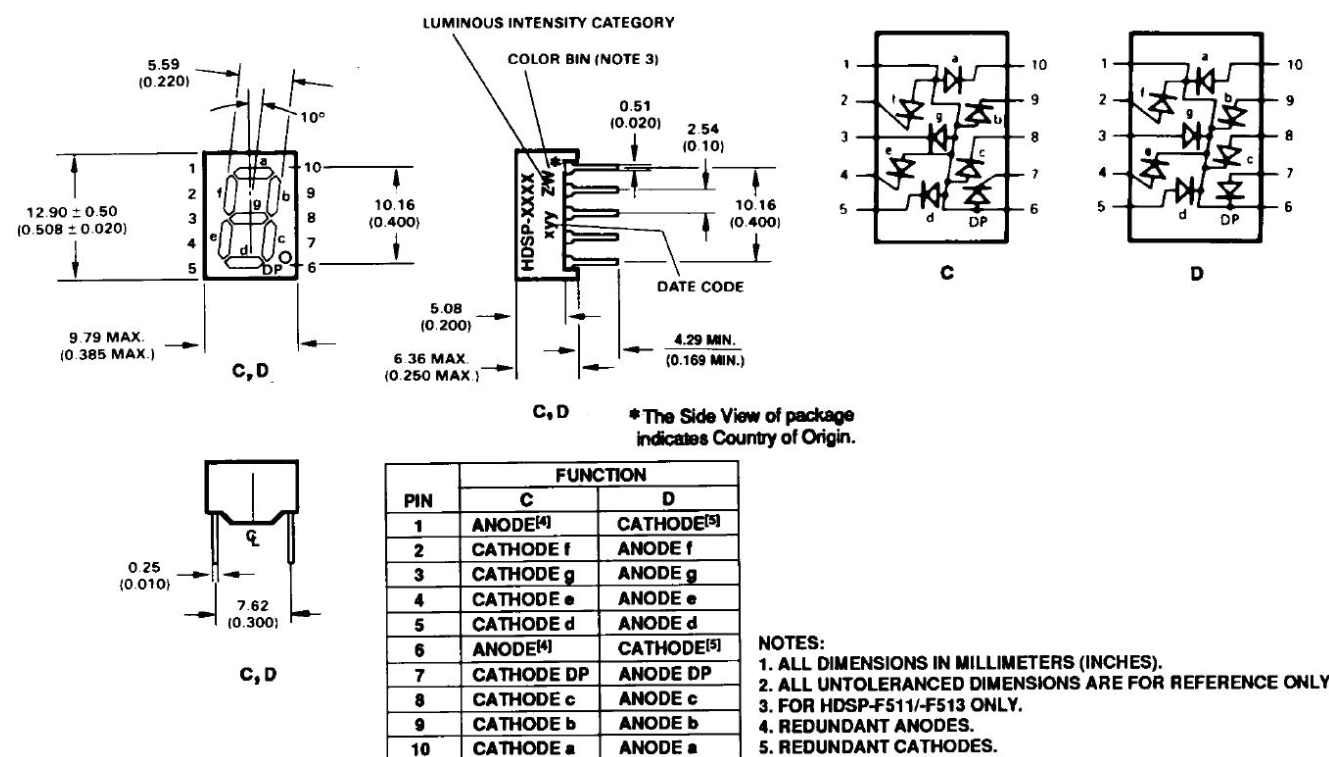


Figure 3: Package Dimensions (14.2-mm Series: Single) and Internal Circuit Diagram

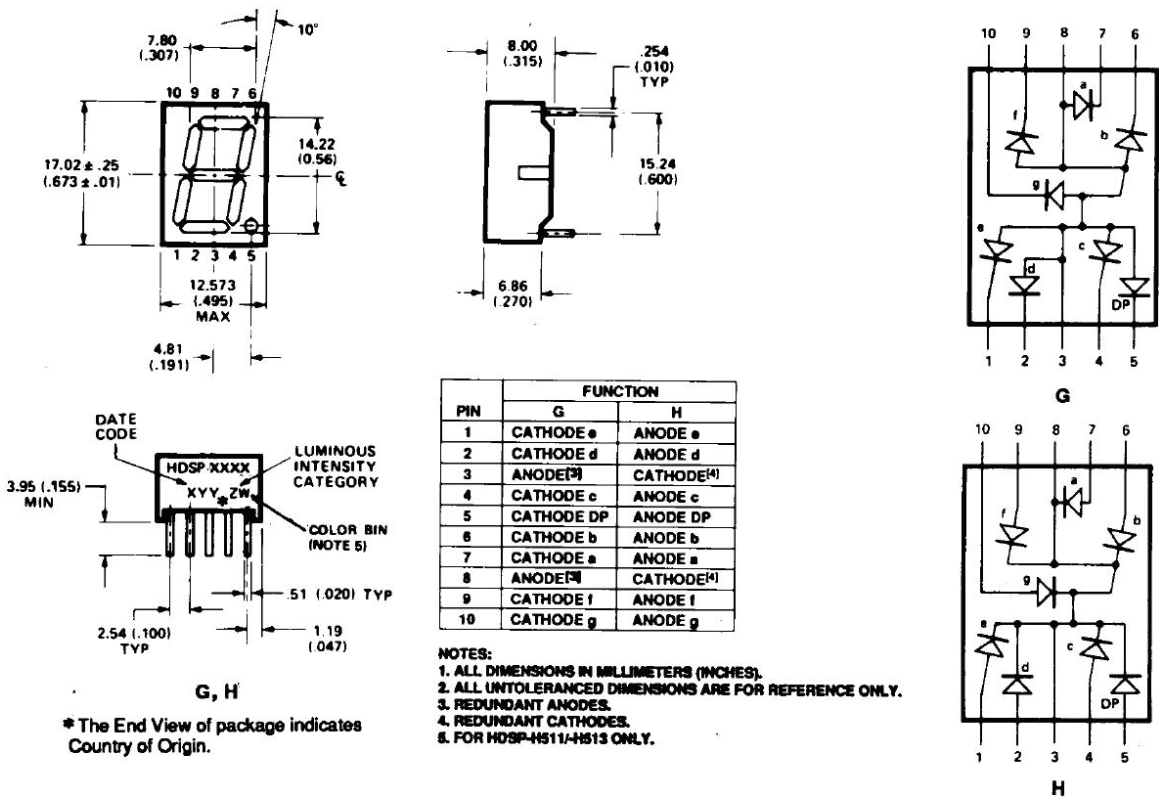
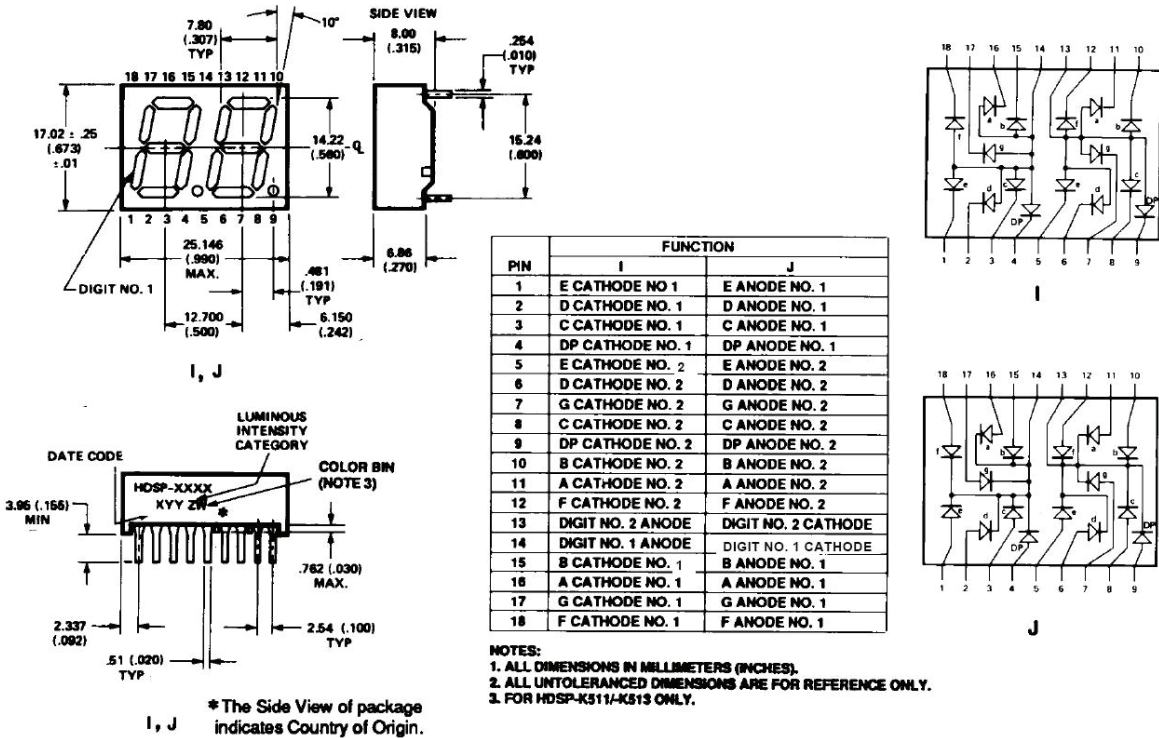


Figure 4: Package Dimensions (14.2-mm Series: Two Digit) and Internal Circuit Diagram



## Device Selection Guide

Orange, HDSP-	AlInGaP Deep Red, HDSP-	HER, HDSP-	Green, HDSP-	Description	Package Drawing
—	A111	A211	A511	7.6-mm Common Anode Righthand Decimal	A
—	A113	A213	A513	7.6-mm Common Cathode Righthand Decimal	B
—	F111	F211	F511	10-mm Common Anode Righthand Decimal	C
F413	F113	F213	F513	10-mm Common Cathode Righthand Decimal	D
—	H111	H211	H511	14.2-mm Common Anode Righthand Decimal	G
H413	H113	H213	H513	14.2-mm Common Cathode Righthand Decimal	H
—	K111	K211	K511	14.2-mm Two-Digit Common Anode Righthand Decimal	I
—	K113	K213	K513	14.2-mm Two-Digit Common Cathode Righthand Decimal	J

## Absolute Maximum Ratings

Parameter	Deep Red HDSP-x11x Series	HER/Orange HDSP-x21x/x41x Series	Green HDSP-x51x Series	Unit
Power Dissipation per Segment or DP	37.5	75	75	mW
Peak Forward Current per Segment or DP <sup>a</sup>	90	90	90	mA
DC Forward Current per Segment or DP <sup>b</sup>	15	30	30	mA
Operating Temperature Range	–20 to +100	–40 to +100	–40 to +100	°C
Storage Temperature Range	–55 to +100			°C
Reverse Voltage per Segment or DP <sup>c</sup>	3.0			V
Wave Soldering Temperature for 3s (1.60 mm [0.063 in.] below body)	250			°C

- Duty factor = 10%, frequency = 1 kHz,  $T_A = 25^{\circ}\text{C}$ .
- Derate linearly as shown in [Figure 8](#) (deep red) and [Figure 12](#) (HER, orange, green).
- Reverse voltage is for LED testing purposes and is not recommended to be used as an application condition.

## Electrical/Optical Characteristics ( $T_A = 25^\circ\text{C}$ )

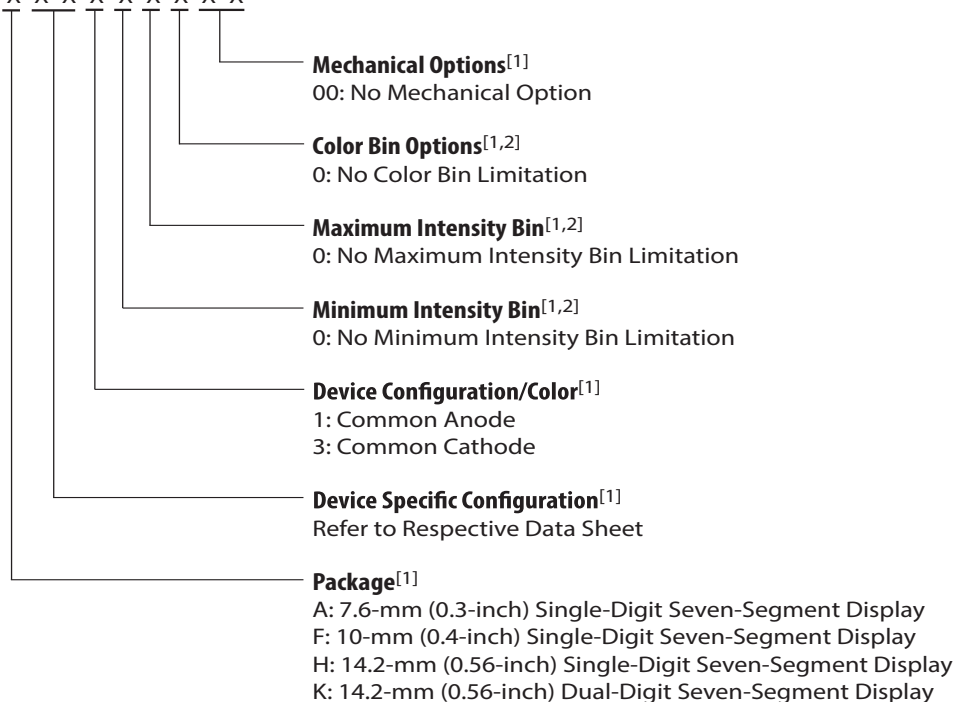
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
<b>Deep Red, Device Series HDSP-A11x/F11x/H11x/K11x</b>						
Luminous Intensity/Segment (Digital Average) <sup>a, b</sup>	$I_V$				mcd	$I_F = 1\text{ mA}$
HDSP-A11x		0.315	0.90	—		
HDSP-F11x		0.33	1.10	—		
HDSP-H11x, K11x		0.40	0.80	—		
Peak Wavelength	$\lambda_p$	—	656	—	nm	
Dominant Wavelength <sup>c</sup>	$\lambda_d$	—	639	—	nm	
Forward Voltage/Segment or DP <sup>d</sup>	$V_F$	—	2.1	2.5	V	$I_F = 20\text{ mA}$
Reverse Voltage/Segment or DP <sup>e</sup>	$V_R$	3.0	—	—	V	$I_R = 100\text{ }\mu\text{A}$
<b>Orange, Device Series HDSP-F413/H413</b>						
Luminous Intensity/Segment (Segment Average) <sup>a, b</sup>	$I_V$				mcd	
HDSP-F413		—	1.0	—		$I_F = 5\text{ mA}$
HDSP-H413		—	2.37	—		$I_F = 10\text{ mA}$
Peak Wavelength	$\lambda_p$	—	600	—	nm	
Dominant Wavelength <sup>c</sup>	$\lambda_d$	—	603	—	nm	
Forward Voltage/Segment or DP <sup>d</sup>	$V_F$	—	2.0	2.5	V	$I_F = 20\text{ mA}$
Reverse Voltage/Segment or DP <sup>e</sup>	$V_R$	3.0	30	—	V	$I_R = 100\text{ }\mu\text{A}$
<b>High-Efficiency Red, Device Series HDSP-A21x/F21x/H21x/K21x</b>						
Luminous Intensity/Segment (Digital Average) <sup>a, b</sup>	$I_V$				mcd	
HDSP-A21x		0.36	0.98	—		$I_F = 5\text{ mA}$
		—	5.39	—		$I_F = 20\text{ mA}$
HDSP-F21x		0.42	1.20	—		$I_F = 5\text{ mA}$
HDSP-H21x/K21x		0.90	2.80	—		$I_F = 10\text{ mA}$
Peak Wavelength	$\lambda_p$	—	635	—	nm	
Dominant Wavelength <sup>c</sup>	$\lambda_d$	—	626	—	nm	
Forward Voltage/Segment or DP <sup>d</sup>	$V_F$	—	2.0	2.5	V	$I_F = 20\text{ mA}$
Reverse Voltage/Segment or DP <sup>e</sup>	$V_R$	3.0	30	—	V	$I_R = 100\text{ }\mu\text{A}$
<b>High-Performance Green, Device Series HDSP-A51x/F51x/H51x/K51x</b>						
Luminous Intensity/Segment (Digital Average) <sup>a, b</sup>	$I_V$				mcd	
HDSP-A51x		0.86	3.00	—		$I_F = 10\text{ mA}$
		—	6.80	—		$I_F = 20\text{ mA}$
HDSP-F51x		1.03	3.50	—		$I_F = 10\text{ mA}$
HDSP-H51x/K51x		0.90	2.50	—		$I_F = 10\text{ mA}$

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Peak Wavelength	$\lambda_p$	—	566	—	nm	
Dominant Wavelength <sup>c</sup>	$\lambda_d$	—	571	577	nm	
Forward Voltage/Segment or DP <sup>d</sup>	$V_F$	—	2.1	2.5	V	$I_F = 20 \text{ mA}$
Reverse Voltage/Segment or DP <sup>e</sup>	$V_R$	3.0	50	—	V	$I_R = 100 \text{ }\mu\text{A}$

- The luminous intensity,  $I_V$ , is measured at the mechanical axis of the package.
- The optical axis is closely aligned with the mechanical axis of the package.
- The dominant wavelength,  $\lambda_d$ , is derived from the CIE Chromaticity Diagram and represents the color of the device.
- Forward voltage tolerance is  $\pm 0.1\text{V}$ .
- Typical specification for reference only. Do not exceed absolute maximum ratings, and long-term reverse bias is not recommended.

## Part Numbering System

5082-X X X X-X X X X X  
HDSP-X X X X-X X X X X



- For codes not listed in the figure, refer to the respective data sheet or contact your Broadcom representative for details.
- Bin options refer to shippable bins for a part number. Color and Intensity Bins are typically restricted to 1 bin per tube (exceptions may apply). Refer to respective data sheet for specific bin limit information.

# Intensity Bin Limits (mcd)

## Deep Red

Table 1: HDSP-A1xx

IV Bin Category	Min.	Max.
E	0.315	0.520
F	0.428	0.759
G	0.621	1.16
H	0.945	1.71
I	1.40	2.56
J	2.10	3.84
K	3.14	5.75
L	4.70	8.55

Table 2: HDSP-F1xx

IV Bin Category	Min.	Max.
D	0.391	0.650
E	0.532	0.923
F	0.755	1.39
G	1.13	2.08
H	1.70	3.14

Table 3: HDSP-H1xx/K1xx

IV Bin Category	Min.	Max.
C	0.415	0.690
D	0.565	0.990
E	0.810	1.50
F	1.20	2.20
G	1.80	3.30
H	2.73	5.00
I	4.09	7.50

## Orange

Table 4: HDSP-F41x

IV Bin Category	Min	Max
C	0.485	0.890
D	0.728	1.333
E	1.091	2.000
F	1.636	3.000
G	2.454	4.500
H	3.682	6.751

Table 5: HDSP-H41x

IV Bin Category	Min	Max
B	0.77	1.17
C	0.95	1.45
D	1.19	1.82
E	1.49	2.27
F	1.85	2.89
G	2.32	3.54
H	2.90	4.43

## HER

Table 6: HDSP-A2xx

IV Bin Category	Min.	Max.
B	0.342	0.630
C	0.516	0.946
D	0.774	1.418
E	1.160	2.127
F	1.740	3.190
G	2.610	4.785
H	3.915	7.177

Table 7: HDSP-F2xx

IV Bin Category	Min.	Max.
C	0.485	0.890
D	0.728	1.333
E	1.091	2.000
F	1.636	3.000
G	2.454	4.500
H	3.682	6.751

Table 8: HDSP-H2xx/K2xx

IV Bin Category	Min.	Max.
E	0.91	1.67
F	1.37	2.51
G	2.05	3.76
H	3.08	5.64
I	4.62	8.64
J	6.93	12.70
K	10.39	19.04



## Green

Table 9: HDSP-A5xx

IV Bin Category	Min.	Max.
H	0.86	1.58
I	1.29	2.37
J	1.94	3.55
K	2.90	5.33
L	4.37	8.01

Table 10: HDSP-F5xx

IV Bin Category	Min.	Max.
H	1.54	2.82
I	2.31	4.23
J	3.46	6.34
K	5.18	9.50
L	7.78	14.26

Table 11: HDSP-H5xx/K5xx

IV Bin Category	Min.	Max.
E	0.91	1.67
F	1.37	2.51
G	2.05	3.76
H	3.08	5.64
I	4.61	8.46

## Color Categories

Color	Bin	Dominant Wavelength (nm)	
		Min.	Max.
Green	2	573.0	577.0
	3	570.0	574.0
	4	567.0	571.0
	5	564.0	568.0

**NOTE:** All categories are established for classification of products. Products may not be available in all categories. Contact your Broadcom representatives for further clarification or information.



# Deep Red Graphs

Figure 5: Relative Intensity vs. Wavelength

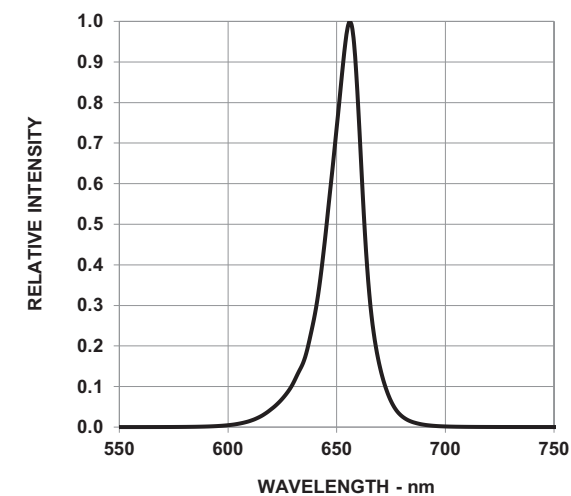


Figure 6: Forward Current vs. Forward Voltage

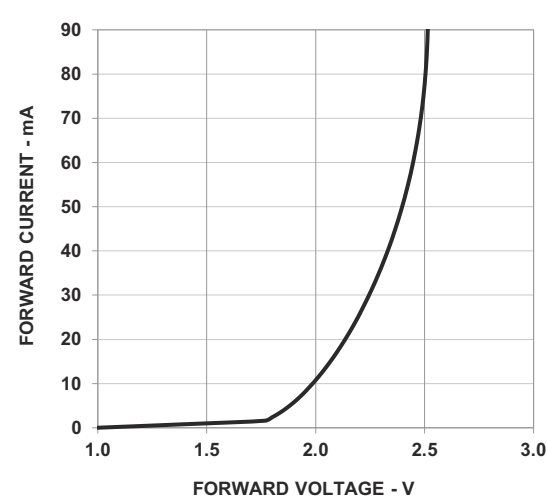


Figure 7: Relative Luminous Intensity vs. Forward Current

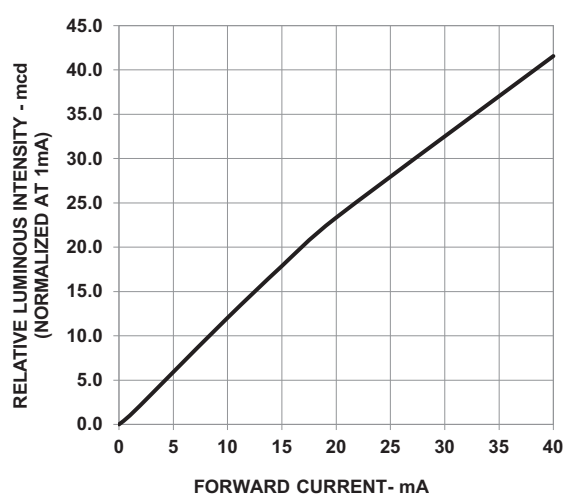
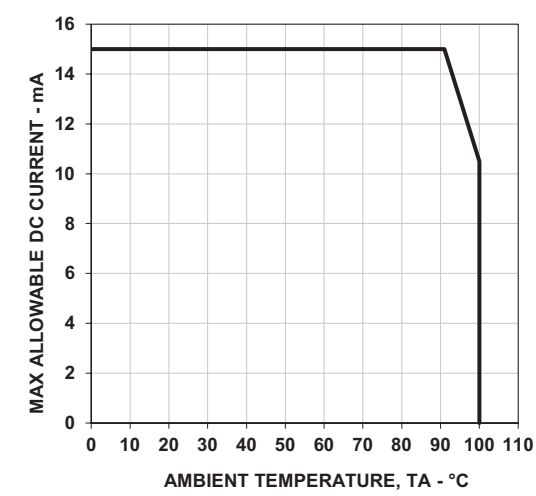


Figure 8: Maximum Forward Current vs. Ambient Temperature



# HER, Orange, Green Graphs

Figure 9: Relative Intensity vs. Wavelength

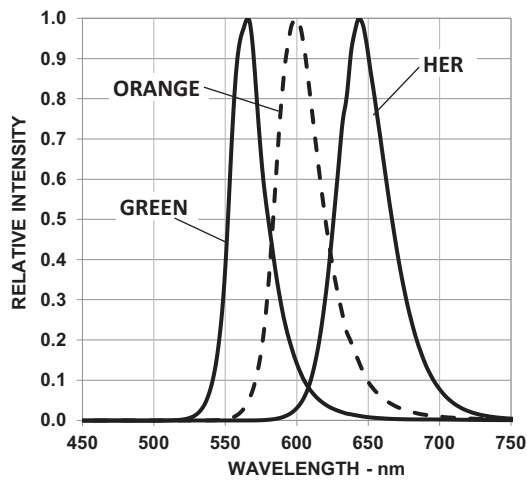


Figure 10: Forward Current vs. Forward Voltage

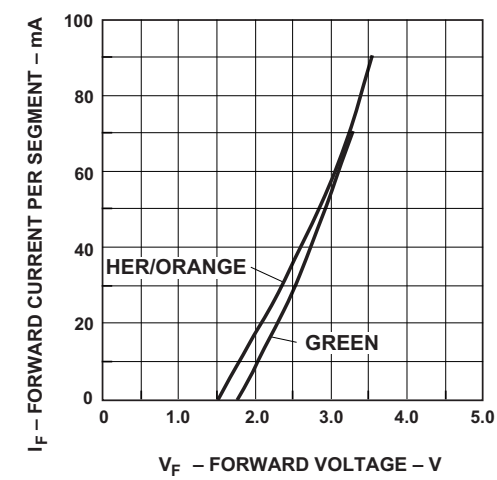


Figure 11: Relative Luminous Intensity vs. Forward Current

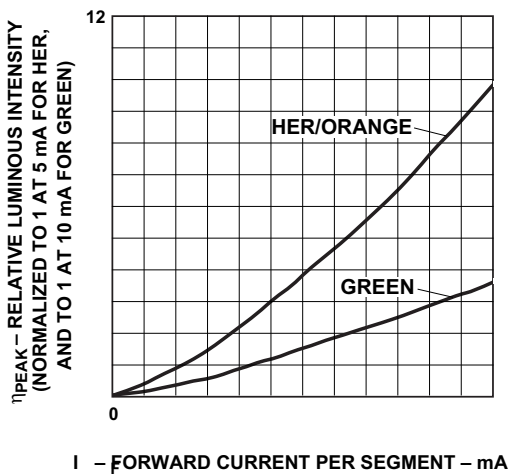
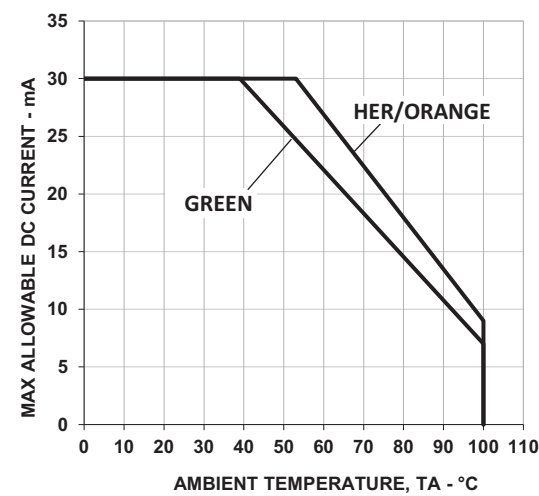


Figure 12: Maximum Forward Current vs. Ambient Temperature



## Precautionary Notes

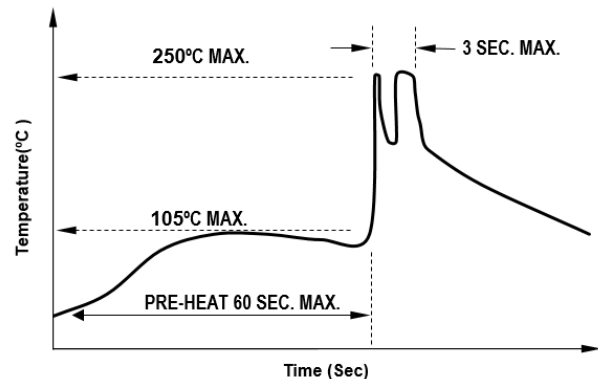
### Soldering and Handling Precautions

- Set and maintain the wave soldering parameters according to the recommended temperature and dwell time. Perform daily checks on the profile to ensure that it is always conforming to the recommended conditions. Exceeding these conditions will over-stress the LEDs and cause premature failures.
- Use only bottom preheaters to reduce thermal stress experienced by the LEDs.
- Recalibrate the soldering profile before loading a new type of a PCB. PCBs with different sizes and designs (component density) will have different heat capacities and might cause a change in temperature experienced by the PCB if the same wave soldering setting is used.
- Do not perform wave soldering more than once.
- Any alignment fixture used during wave soldering must be loosely fitted and must not apply stress on the LEDs. Use non-metal material because it will absorb less heat during the wave soldering process.
- At elevated temperatures, the LEDs are more susceptible to mechanical stress. Allow the PCB to be sufficiently cooled to room temperature before handling. Do not apply stress to the LED when it is hot.
- Use wave soldering to solder the LED. Use hand soldering only for rework or touch up if unavoidable, but it must be strictly controlled to following conditions:
  - Soldering iron tip temperature = 315°C maximum.
  - Soldering duration = 2 seconds maximum.
  - Number of cycles = 1 only.
  - Power of soldering iron = 50W maximum.
- For ESD-sensitive devices, apply proper ESD precautions at the soldering station. Use only an ESD-safe soldering iron.
- Do not touch the LED package body with the soldering iron except for the soldering terminals because it may cause damage to the LED.
- Confirm beforehand whether the functionality and performance of the LED is affected by soldering with hand soldering.
- Keep the heat source at least 1.6 mm away from the LED body during soldering.
- Design an appropriate hole size to avoid problems during insertion.
- Cleaning agents from the ketone family (acetone, methyl ethylketone, and so on) and from the chlorinated hydrocarbon family (methylene chloride,

trichloroethylene, carbon tetrachloride, and so on) are not recommended for cleaning the LED displays. All of these various solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

- For the purpose of cleaning, wash with DI water only. The cleaning process should take place at room temperature only. Clear any water or moisture from the LED display immediately after washing.
- Use of *No clean* solder paste is recommended for soldering.

Figure 13: Recommended Wave Soldering Profile



**NOTE:** Figure 13 refers to measurements with thermocouple mounted at the bottom of the PCB.

### Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperatures as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- Circuit design must cater to the whole range of forward voltage ( $V_F$ ) of the LEDs to ensure the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (such as intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.

- Avoid rapid change in ambient temperatures, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in a harsh or outdoor environment, protect the LED against damages caused by rain, water, dust, oil, corrosive gases, external mechanical stresses, and so on.

## Eye Safety Precautions

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment.

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